# At A Glance

Multivendor 386/486 Market Burgeoning1
Over the past year, the x86 market has become truly competitive, as
Intel has been joined by AMD, Cyrix, TI, and IBM. This competition
has spurred vendors not only to cut prices, but also to offer a wider
range of products filling every conceivable price/performance point.
Somehow, Intel continues to thrive in this new environment.
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Starting with this issue, senior editor Linley Gwennap will share the
EDITORS' VIEW column with editor-in-chief Michael Slater. (Note the
small but significant relocation of the apostrophe to the right of the
"S.") In this column, Linley describes how most microprocessor vendors
have been driven to discussing their product plans years in advance.
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GUI-Ultra plans.
What to Expect from RISC Vendors in 19935
Several new high-end SPARC chips will debut in 1993, along with fast
new chips from other RISC vendors. For a change, these vendors are
also developing low-cost chips that will compete with Pentium and
other x86 CPUs.
PCMCIA Chips Follow Intel's Lead15
Several vendors are now offering chips that interface PCMCIA cards
to an ISA bus. Intel's 82365 sets the standard, while Cirrus and
Vadem offer register-compatible chips with some extensions.
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